

Vishay

ROHS

16 x 2 Character LCD



FEATURES

• Type: character

• Display format: 16 x 2 characters

• Built-in controller: ST7066 (or equivalent)

• Duty cycle: 1/16

• 5 x 8 dots includes cursor

• +5 V power supply

• LED can be driven by pin 1, pin 2, pin 15, pin 16 or A and K

 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

MECHANICAL DATA							
ITEM	STANDARD VALUE	UNIT					
Module dimension	84.0 x 44.0 x 13.2 (max.)						
Viewing area	66.0 x 16.0						
Active area	56.2 x 11.5						
Dot size	0.55 x 0.65	mm					
Dot pitch	0.60 x 0.70						
Mounting hole	76.0 x 36.0						
Character size	2.95 x 5.55						

ABSOLUTE MAXIMUM RATINGS									
ITEM	SYMBOL	STAN	IDARD V	ALUE	UNIT				
I I EIVI	STIVIBUL	MIN.	TYP.	MAX.	UNII				
Supply voltage for logic	V _{DD} to V _{SS}	-0.3	-	7.0					
Supply voltage for LCD	V _{DD} to V ₀	-0.3	-	13.0	V				
Input voltage	VI	V_{SS}	-	V_{DD}					
Operating temperature	T _{OP}	-20	-	+70	°C				
Storage temperature	T _{ST}	-30	-	+80	°C				

Note

• $V_{SS} = 0 \text{ V}, V_{DD} = 5.0 \text{ V}$

ELECTRICAL CHARACTERISTICS								
ITEM	SYMBOL	CONDITION	ST	STANDARD VALUE				
ITEM	STIVIDOL	CONDITION	MIN.	TYP.	MAX.	UNIT		
Supply voltage for logic	V _{DD} to V _{SS}	-	4.5	5.0	5.5	V		
		-20 °C	-	-	5.2			
Supply voltage for LCD (1)	V_{DD} to V_{0}	25 °C	-	3.8	-	V		
		70 °C	3.2	-	-			
Input high voltage	V _{IH}	-	0.7 V _{DD}	-	V_{DD}	V		
Input low voltage	V _{IL}	-	V _{SS}	-	0.6	mA		
Output high voltage	V _{OH}	-	3.9	-	-	V		
Output low voltage	V _{OL}	-	-	-	0.4	mA		
Supply current	I _{DD}	$V_{DD} = +5 \text{ V}$	1.0	1.2	1.5	mA		

Note

Please design the VOP adjustment circuit on customer's main board

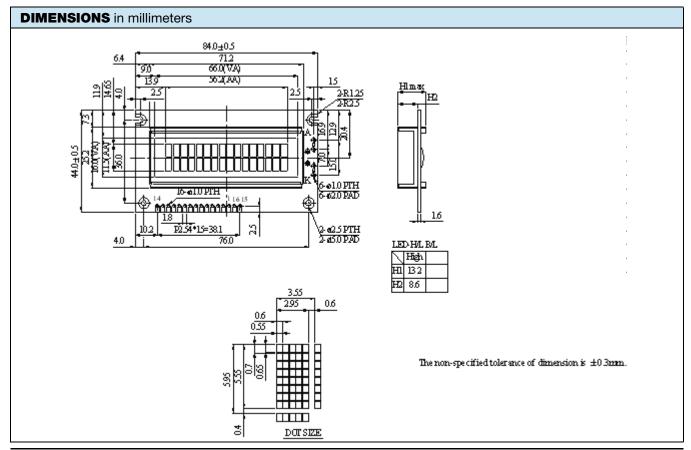
OPTIONS	S								
		PROCES	S COLOR			BACK	LIGHT		
TN	STN GRAY	STN YELLOW	STN BLUE	FSTN B&W	STN COLOR	NONE	LED	EL	CCFL
yes	yes	yes	yes	yes	-	yes	yes	-	-

Revision: 17-Aug-15 1 Document Number: 37513



Display position			DISPLAY CHARACTER ADDRESS CODE												
Display position															
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DD RAM address 00	01	02	03	04	05	06	07	80	09	0A	0B	0C	0D	0E	0F
DD RAM address 40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F

INTERFACE PIN FUNCTION							
PIN NO.	SYMBOL	FUNCTION					
1	V _{SS}	Ground					
2	V _{DD}	Power supply voltage for logic (+5 V)					
3	V _O	Operating voltage (variable)					
4	RS	H / L; H: data / L: instruction code					
5	R/W	H / L; H: read (MPU \rightarrow module) / L: write (MPU \rightarrow module)					
6	E	$H, H \rightarrow L$ chip enable signal					
7	DB0	H / L data bus line					
8	DB1	H / L data bus line					
9	DB2	H / L data bus line					
10	DB3	H / L data bus line					
11	DB4	H / L data bus line					
12	DB5	H / L data bus line					
13	DB6	H / L data bus line					
14	DB7	H / L data bus line					
15	A	LED+					
16	К	LED-					



Revision: 17-Aug-15 2 Document Number: 37513

Vishay

1. Module Classification Information

<u>LCD- 016 N 002 A -Y Y H -ET</u>

Brand: Vishay Intertechnology
 Horizontal Format: 16 characters

3. Display Type : N→Character Type (RoHS), M→Character Type

4. Vertical Format: 2 lines5. Model serials no.: A

6. Backlight N→Without backlight T→LED, White
Type: B→EL, Blue green A→LED, Amber
D→EL, Green R→LED, Red
W→EL, White O→LED, Orange
E→CCFL White

 $F\rightarrow$ CCFL, White $G\rightarrow$ LED, Green $Y\rightarrow$ LED, Yellow Green $B\rightarrow$ LED, Blue

7. LCD Mode : B→TN Positive, Gray T→FSTN Negative

N→TN Negative, G→STN Positive, Gray

Y→STN Positive, Yellow Green

M→STN Negative, Blue

F→FSTN Positive

8. LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00
Type/ Temperature range/ View G→Reflective, W. T, 6:00 G→Reflective, W. T, 6:00 G→Reflective, W. T, 6:00 G→Transmissive, N.T,6:00 F→Transmissive, N.T,12:00 F→Transmissive, N.T,12:00 L→Transmissive, W.T. 6:00 G→Transmissive, W.T. 6:00 G→T

B→Transflective, N.T,6:00 I→Transmissive, W.T,6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

9. Special Code ET: English and European standard font;

Fits in with the ROHS Directions and regulations



2. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.

3. General Specification

Item	Dimension	Unit
Number of Characters	16 characters x 2 Lines	_
Module dimension	84.0 x 44.0 x 13.2(MAX)	mm
View area	66.0 x 16.0	mm
Active area	56.20 x 11.5	mm
Dot size	0.55 x 0.65	mm
Dot pitch	0.60 x 0.70	mm
Character size	2.95 x 5.55	mm
Character pitch	3.55 x 5.95	mm
LCD type	STN Positive, Transflective, Yellow Green	1
Duty	1/16	
View direction	6 o'clock	
Backlight Type	LED Yellow green	



4. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	°C
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	$V_{\rm I}$	V_{SS}	_	V_{DD}	V
Supply Voltage For Logic	Vdd-Vss	-0.3	_	7	V
Supply Voltage For LCD	$ m V_{DD} ext{-}V_0$	-0.3	_	13	V

5. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V _{DD} -V _{SS}	_	4.5	5.0	5.5	V
Supply Voltage For	V_{DD} - V_{0}	Ta=-20°C Ta=25°C	_	3.8	5.2	V V
LCD	▼ DD- ▼ 0	Ta=70°C	3.2	- -	_	V
Input High Volt.	$V_{ m IH}$	_	$0.7~\mathrm{V_{DD}}$	_	V_{DD}	V
Input Low Volt.	V_{IL}	_	V_{SS}	_	0.6	V
Output High Volt.	V _{OH}	_	3.9	_	_	V
Output Low Volt.	V _{OL}	_	_	_	0.4	V
Supply Current	I_{DD}	$V_{DD}=5.0V$	1.0	1.2	1.5	mA

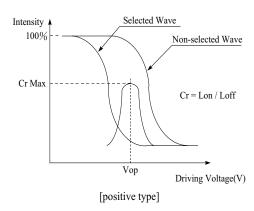


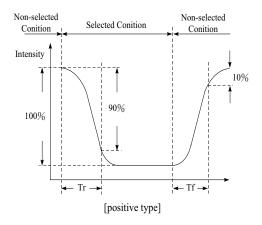
6. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V) θ	CR≧2	20	_	40	deg
view i mgie	(H) φ	CR≧2	-30	_	30	deg
Contrast Ratio	CR	_	_	3	_	_
Response Time @25C	T rise	_	_	150	200	ms
	T fall	_	_	150	200	ms

Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)





Conditions:

Downloaded from **Arrow.com**.

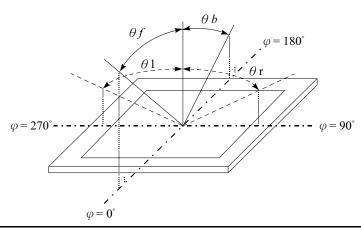
Operating Voltage: Vop

Viewing Angle(θ , φ): 0° , 0°

Frame Frequency: 64 HZ

Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle($CR \ge 2$)



Revision: 17-Aug-15 6 Document Number: 37513

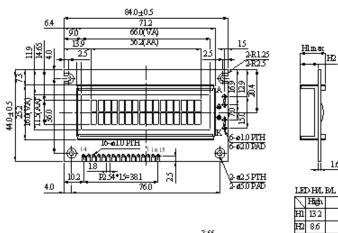


7. Interface Pin Function

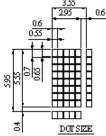
Pin No.	Symbol	Level	Description
1	V_{SS}	0V	Ground
2	V_{DD}	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU→Module) L: Write(MPU→Module)
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	A	_	LED +
16	K		LED-



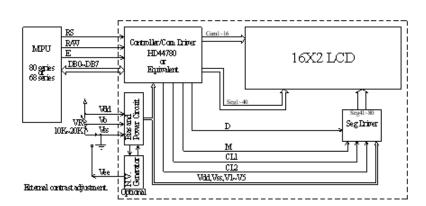
8. Contour Drawing & Block Diagram



PN 80.	SYMBOL
1	Vss
2	Vdd
3	Vo
4	RS
5	R ∕W
6	E
7	DB0
8	DBl
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	A
16	K



The non-specified tolerance of dimension is ± 0.3 mm.



Character located 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16

DDRAMaddress 00 01 02 03 04 05 06 07 08 09 DA 0B0C DD 0E 0F

DDRAMaddress 40 41 42 43 44 45 46 47 48 49 A 4B4C 4D 4E 4F



9. Function Description

The LCD display Module is built in a LSI controller, the controller has two 8-bit registers, an instruction register (IR) and a data register (DR).

The IR stores instruction codes, such as display clear and cursor shift, and address information for display data RAM (DDRAM) and character generator (CGRAM). The IR can only be written from the MPU. The DR temporarily stores data to be written or read from DDRAM or CGRAM. When address information is written into the IR, then data is stored into the DR from DDRAM or CGRAM. By the register selector (RS) signal, these two registers can be selected.

RS	R/W	Operation
0	0	IR write as an internal operation (display clear, etc.)
0	1	Read busy flag (DB7) and address counter (DB0 to DB7)
1	0	Write data to DDRAM or CGRAM (DR to DDRAM or CGRAM)
1	1	Read data from DDRAM or CGRAM (DDRAM or CGRAM to DR)

Busy Flag (BF)

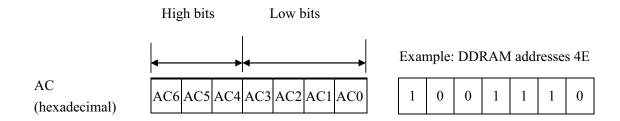
When the busy flag is 1, the controller LSI is in the internal operation mode, and the next instruction will not be accepted. When RS=0 and R/W=1, the busy flag is output to DB7. The next instruction must be written after ensuring that the busy flag is 0.

Address Counter (AC)

The address counter (AC) assigns addresses to both DDRAM and CGRAM

Display Data RAM (DDRAM)

This DDRAM is used to store the display data represented in 8-bit character codes. Its extended capacity is 80x8 bits or 80 characters. Below figure is the relationships between DDRAM addresses and positions on the liquid crystal display.



Vishay

Display position DDRAM address

1	2	2	1	-	6	7	0	Ω	10	11	12	12	1 /	15	16
1		3	4	3	O	/	0	9	10	11	12	13	14	13	10

00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F

2-Line by 16-Character Display

Character Generator ROM (CGROM)

The CGROM generate 5×8 dot or 5×10 dot character patterns from 8-bit character codes. See Table 2.

Character Generator RAM (CGRAM)

In CGRAM, the user can rewrite character by program. For 5×8 dots, eight character patterns can be written, and for 5×10 dots, four character patterns can be written.

Write into DDRAM the character code at the addresses shown as the left column of table 1. To show the character patterns stored in CGRAM.

Vishay

Relationship between CGRAM Addresses, Character Codes (DDRAM) and Character patterns

Table 1.

For 5 * 8 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0	5 4 3 2 1 0	7 6 5 4 3 2 1 0	
High Low	High Low	High Low	
0 0 0 0 * 0 0 0	0 0 0 0 0 0 0 1 0 1 0 0 1 1 0 0 1 0 0 1 1 1 1 1 1 1 0 0 0 0 0	* * * * * * * * * * * * * * * * * * *	Character pattern(1) Cursor pattern
0 0 0 0 * 0 0 1	0 0 1 0 1 0 0 1 1 0 0 1 1 0 0 1 1 0 1 1 1 0 0 0 0	* * * * O O O O O O O O O O O O O O O O	Character pattern(2) Cursor pattern
	0 0 0	†	
0 0 0 0 * 1 1 1	1 1 1 1 0 0 1 0 1 1 1 0 1 1 1	* * *	

For 5 * 10 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0	5 4 3 2 1 0	7 6 5 4 3 2 1 0	
High Low	High Low	High Low	
0 0 0 0 * 0 0 0	0 0 0 0 0 0 0 0 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 1 0 0 0 1 1 1 1 1 1 1 0 0 0 0 1 1 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0	* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Character pattern Cursor pattern
	1 1 1 1	* * * * * * *	

■ : " High "



10. Character Generator ROM Pattern

Table 2.

Upper																
4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH		LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	нннн
LLLL	CG RAM (1)	**[**					==	!			-:::1	-	, " ! !			****
LLLH	CG RAM (2)	*****	1				-::::	-:::[· · · · · · · · · · · · · · · · · · ·			= =			*: : :	1.,;:
LLHL	CG RAM (3)		11	:				!-""			:::::::::::::::::::::::::::::::::::::::	-:-	1,1,1	****		-1-1
LLHH	CG RAM (4)						====	-***	-:::	,". :":	,. !!	*•			====	
LHLL	CG RAM (5)		-: :-			*****	! !		****	=====		="	-!:-!		***** *****	
LHLH	CG RAM (6)		"::				1	I[", !""!		1		.::[*****
LHHL	CG RAM (7)	*		=====				I.,.I	***	.". !!			****			!!!
LHHH	CG RAM (8)	. #	==	****			-::::	1,:,1	*****	". !!]:-:]	; -	; [‡] ;	Ĭ.,	!!!
HLLL	CG RAM (1)	_	!	=====			ļ _i	[:-:			-:[-"		-1;	11	j.;.	
HLLH	CG RAM (2)	*. !		*		" "	1	1111			1	***			.;;;	****
HLHL	CG RAM (3)	."."	[11	-,		!			[]		", ""			ļ	
НГНН	CG RAM (4)]	:=	# " #		i-:	-=-	***	;	-:::	-:::		=======================================	i,.::	
HHLL	CG RAM (5)		: =	-=-		****	1		* * * * * * * * * * * * * * * * * * * *]:::-				
HHLH	CG RAM (6)	="=,=		****		***		** :	**	****	****		11			*****
НННГ	CG RAM (7)		11			"***	-**	***,*				***			!""! !""!	
нннн	CG RAM (8)		"	****			! <u></u> }	::::	::: !!	¥	=====				!!	

Revision: 17-Aug-15 12 Document Number: 37513



11. Instruction Table

Instruction				Ins	structi	on Co	ode				Description	Execution time
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	(fosc=270Khz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "00H" to DDRAM and set DDRAM address to "00H" from AC	1.53ms
Return Home	0	0	0	0	0	0	0	0	1		Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	$39 \mu\mathrm{s}$
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	Set display (D), cursor (C), and blinking of cursor (B) on/off control bit.	39 μ s
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	_	_	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 μ s
Function Set	0	0	0	0	1	DL	N	F			Set interface data length (DL:8-bit/4-bit), numbers of display line (N:2-line/1-line)and, display font type (F:5×11 dots/5×8 dots)	39 μ s
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39 μ s
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	$39 \mu\mathrm{s}$
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 μ s
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43 μ s
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43 μ s

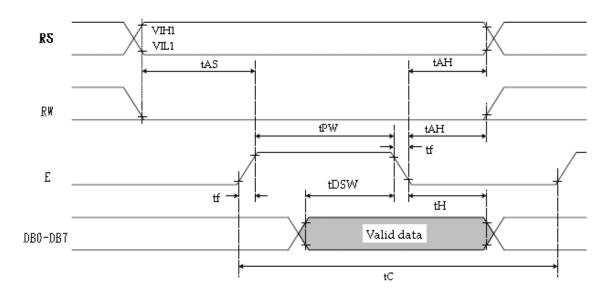
* "-": don't care



12. Timing Characteristics

12.1 Write Operation

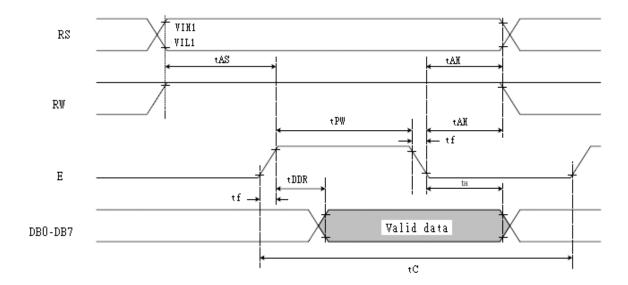
Writing data from MPU



 $Ta=25^{\circ}C$, VDD=5.0V

Item	Symbol	Min	Тур	Max	Unit
Enable cycle time	$T_{\rm C}$	1200	_	_	ns
Enable pulse width	T_{PW}	140	_	_	ns
Enable rise/fall time	T_R, T_F	_	_	25	ns
Address set-up time (RS, R/W to E)	t_{AS}	0	_	_	ns
Address hold time	$t_{ m AH}$	10	_	_	ns
Data set-up time	$t_{ m DSW}$	40	_	_	ns
Data hold time	t_{H}	10			ns

Reading data from \$T7066U

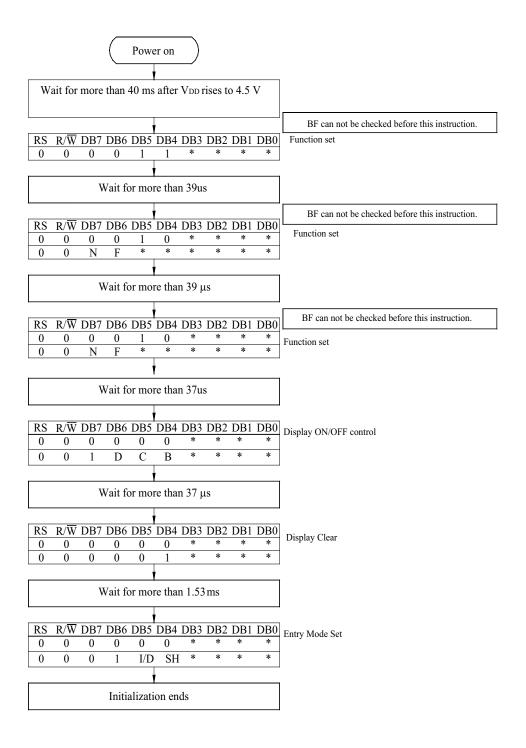


 $Ta=25^{\circ}C$, VDD=5V

Item	Symbol	Min	Тур	Max	Unit
Enable cycle time	Tc	1200	_	_	ns
Enable pulse width (high level)	T_{PW}	140	_	_	ns
Enable rise/fall time	T_R,T_F	_	_	25	ns
Address set-up time (RS, R/W to E)	t _{AS}	0	_	_	ns
Address hold time	$t_{ m AH}$	10	_	_	ns
Data delay time	$t_{ m DDR}$	_	_	100	ns
Data hold time	t_{H}	10	_	_	ns

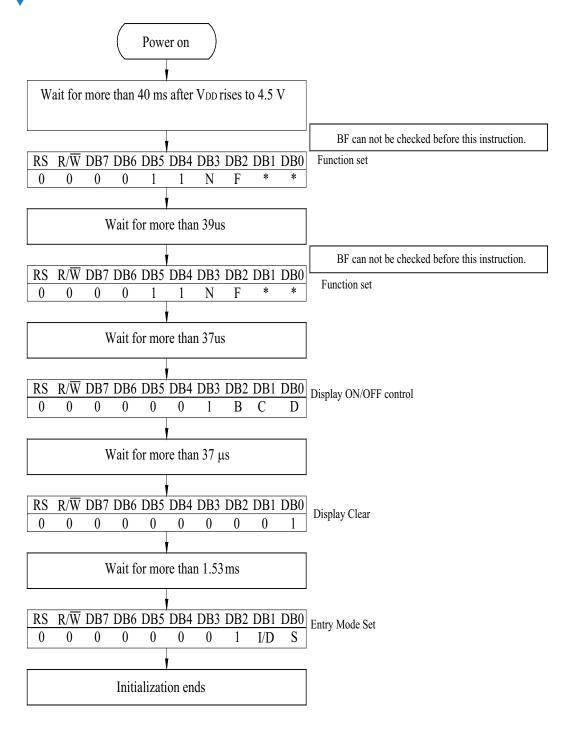


13. Initializing of LCM



4-Bit Ineterface

Vishay



8-Bit Ineterface



14. Reliability

Content of Reliability Test (wide temperature, -20℃~70℃)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°ℂ 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.



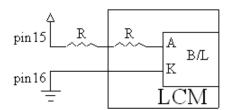
15. Backlight Information

Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	104	130	150	mA	V=4.2V
Supply Voltage	V	4.0	4.2	4.4	V	_
Reverse Voltage	VR	_	_	8	V	_
Luminous Intensity	IV	60	80	_	CD/M ²	ILED=130mA
Wave Length	λp	560	570	580	nm	ILED=130mA
Life Time	_	_	100000	_	Hr.	ILED≤130mA
Color	Yellow C	Freen	L	I		

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

2.Drive from pin15,pin16



(Will never get Vee output from pin15)

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.